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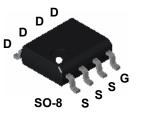
FDS6679AZ P-Channel PowerTrench[®] MOSFET -30V, -13A, 9mΩ

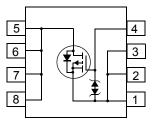
General Description

This P-Channel MOSFET is producted using ON Semiconductor's advanced PowerTrench process that has been especially tailored to minimize the on-state resistance.

This device is well suited for Power Management and load switching applications common in Notebook Computers and Portable Battery Packs.







Features

r_{DS(on)}

RoHS Compliant

• Max $r_{DS(on)}$ = 9.3m Ω at V_{GS} = -10V, I_D = -13A

■ Max r_{DS(on)} = 14.8mΩ at V_{GS} = -4.5V, I_D = -11A

Extended V_{GS} range (-25V) for battery applications

■ HBM ESD protection level of 6kV typical (note 3)

High power and current handing capability

MOSFET Maximum Ratings T_A = 25°C unless otherwise noted

Symbol	Parameter		Ratings	Units	
V _{DS}	Drain to Source Voltage		-30	V	
V _{GS}	Gate to Source Voltage		±25	V	
	Drain Current -Continuous	(Note 1a)	-13		
D	-Pulsed		-65	A	
	Power Dissipation for Single Operation	(Note 1a)	2.5	w	
P _D		(Note 1b)	1.2		
		(Note 1c)	1.0		
T _J , T _{STG}	Operating and Storage Temperature		-55 to +150	°C	

Thermal Characteristics

R_{\thetaJA}	Thermal Resistance, Junction to Ambient (Note 1a)	50	°C/W
$R_{\theta JC}$	Thermal Resistance, Junction to Case (Note 1)	25	°C/W

Package Marking and Ordering Information

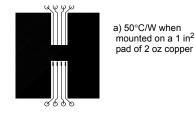
Device Marking	Device	Reel Size	Tape Width	Quantity
FDS6679AZ	FDS6679AZ	13"	12mm	2500 units

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teristics Drain to Source Breakdown Voltage					
	I _D = -250μA, V _{GS} = 0V	-30			V
Breakdown Voltage Temperature Coefficient	$I_D = -250\mu A$, referenced to $25^{\circ}C$		-20		mV/°C
Zero Gate Voltage Drain Current	V _{DS} = -24V, V _{GS} =0V			-1	μA
Gate to Source Leakage Current	V_{GS} = ±25V, V_{DS} =0V			±10	μA
teristics (Note 2)					
Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = -250 \mu A$	-1	-1.9	-3	V
Gate to Source Threshold Voltage Temperature Coefficient	I_D = -250µA, referenced to 25°C		6.5		mV/°C
	V _{GS} = -10V, I _D = -13A		7.7	9.3	mΩ
Drain to Source On Resistance	V _{GS} = -4.5V, I _D = -11A		11.8	14.8	
	V _{GS} = -10V, I _D = -13A, T _J = 125°C		10.7	13.4	11122
Forward Transconductance	V _{DS} = -5V, I _D = -13A		55		S
haracteristics					
Input Capacitance	V _{DS} = -15V, V _{GS} = 0V, f = 1MHz		2890	3845	pF
Output Capacitance			500	665	pF
Reverse Transfer Capacitance			495	745	pF
Characteristics (Note 2)					
Turn-On Delay Time			13	24	ns
Rise Time			15	27	ns
Turn-Off Delay Time	$V_{GS} = -100, R_{GS} = 002$		210	336	ns
Fall Time			92	148	ns
Total Gate Charge	V _{DS} = -15V, V _{GS} = -10V, I _D = -13A		68	96	nC
Total Gate Charge	$V_{\rm DS} = -15V, V_{\rm GS} = -5V,$		38	54	nC
Gate to Source Gate Charge			10		nC
Gate to Drain Charge			17		nC
	teristics (Note 2) Gate to Source Threshold Voltage Gate to Source Threshold Voltage Temperature Coefficient Drain to Source On Resistance Forward Transconductance haracteristics Input Capacitance Output Capacitance Reverse Transfer Capacitance Characteristics (Note 2) Turn-On Delay Time Rise Time Turn-Off Delay Time Fall Time Total Gate Charge Gate to Source Gate Charge	teristics (Note 2)Gate to Source Threshold Voltage $V_{GS} = V_{DS}$, $I_D = -250\mu A$ Gate to Source Threshold Voltage $I_D = -250\mu A$, referenced to $25^{\circ}C$ Drain to Source On Resistance $V_{GS} = -10V$, $I_D = -13A$ Drain to Source On Resistance $V_{GS} = -10V$, $I_D = -13A$, $T_J = 125^{\circ}C$ Forward Transconductance $V_{DS} = -5V$, $I_D = -13A$ haracteristics $V_{DS} = -5V$, $I_D = -13A$ Input Capacitance $V_{DS} = -5V$, $I_D = -13A$ Dutput Capacitance $V_{DS} = -15V$, $V_{GS} = 0V$, $f = 1MHz$ Characteristics (Note 2)Turn-On Delay TimeTurn-On Delay Time $V_{DS} = -15V$, $I_D = -1A$ Fail Time $V_{DS} = -15V$, $V_{GS} = 6\Omega$ Total Gate Charge $V_{DS} = -15V$, $V_{GS} = -10V$, $I_D = -13A$ Total Gate Charge $V_{DS} = -15V$, $V_{GS} = -5V$, $I_D = -13A$ Gate to Drain Charge $V_{DS} = -15V$, $V_{GS} = -5V$, $I_D = -13A$	teristics (Note 2)Gate to Source Threshold Voltage $V_{GS} = V_{DS}$. $I_D = -250\mu$ A-1Gate to Source Threshold Voltage $I_D = -250\mu$ A, referenced to 25° C-1Drain to Source On Resistance $V_{GS} = -10V$, $I_D = -13A$ $V_{GS} = -4.5V$, $I_D = -11A$ Drain to Source On Resistance $V_{DS} = -10V$, $I_D = -13A$, $T_J = 125^{\circ}$ C-1Forward Transconductance $V_{DS} = -5V$, $I_D = -13A$ -1HaracteristicsInput Capacitance $V_{DS} = -5V$, $I_D = -13A$ -1Input Capacitance $V_{DS} = -5V$, $V_{GS} = 0V$, $f = 1MHz$ -1Characteristics (Note 2)Turn-On Delay Time Rise Time $V_{DD} = -15V$, $I_D = -1A$ $V_{GS} = -10V$, $R_{GS} = 6\Omega$ Total Gate Charge $V_{DS} = -15V$, $V_{GS} = -10V$, $I_D = -13A$ -1Total Gate Charge $V_{DS} = -15V$, $V_{GS} = -5V$, $I_D = -13A$ -1Gate to Drain Charge $V_{DS} = -13V$, $V_{GS} = -5V$, $I_D = -13A$ -1	teristics (Note 2)Gate to Source Threshold Voltage $V_{GS} = V_{DS}$, $I_D = -250\mu$ A-1-1.9Gate to Source Threshold Voltage $I_D = -250\mu$ A, referenced to6.5Temperature Coefficient $V_{GS} = -10V$, $I_D = -13A$ 7.7Drain to Source On Resistance $V_{GS} = -4.5V$, $I_D = -11A$ 11.8 $V_{GS} = -10V$, $I_D = -13A$, $T_J = 125^{\circ}C$ 10.7Forward Transconductance $V_{DS} = -5V$, $I_D = -13A$ 55haracteristicsInput Capacitance $V_{DS} = -15V$, $V_{GS} = 0V$, f = 1MHz2890Output Capacitance $V_{DS} = -15V$, $V_{GS} = 0V$, f = 1MHz500Characteristics (Note 2)13Turn-On Delay Time $V_{DD} = -15V$, $I_D = -1A$ $V_{GS} = -10V$, $R_{GS} = 6\Omega$ 15Fall Time92210Total Gate Charge $V_{DS} = -15V$, $V_{GS} = -5V$, $I_D = -13A$ 68Total Gate Charge $V_{DS} = -15V$, $V_{GS} = -5V$, $I_D = -13A$ 38Gate to Drain Charge $V_{DS} = -15V$, $V_{GS} = -5V$, $I_D = -13A$ 10	The set of the second product of the second

'	V _{SD}	Source to Drain Diode Forward Voltage	V _{GS} = 0V, I _S = -2.1A	-0.7	-1.2	V
1	t _{rr}	Reverse Recovery Time	I _F = -13A, di/dt = 100A/μs		40	ns
(Q _{rr}	Reverse Recovery Charge	I _F = -13A, di/dt = 100A/μs		-31	nC

Notes:
I: R_{0JA} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{0JC} is guaranteed by design while R_{0CA} is determined by the user's board design.



Scale 1 : 1 on letter size paper

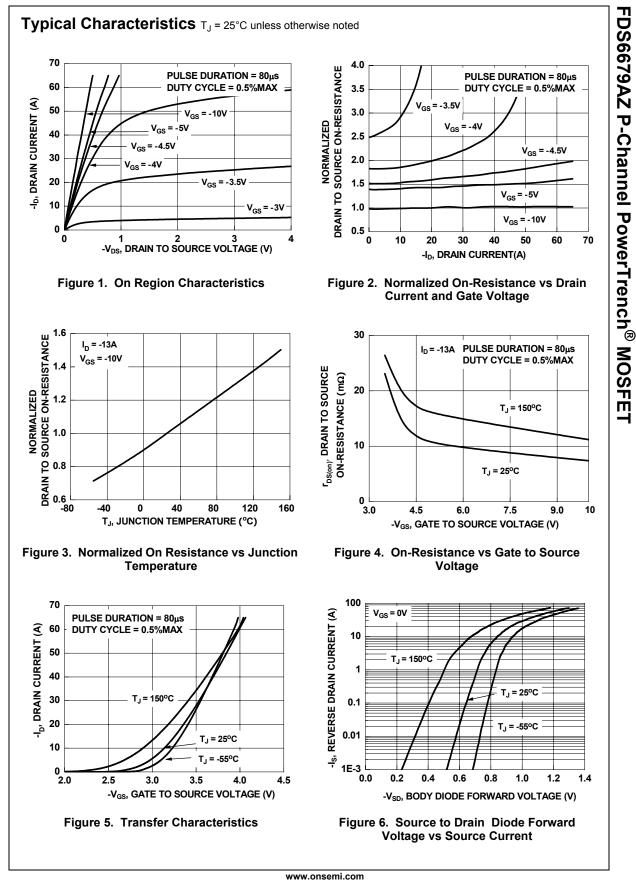


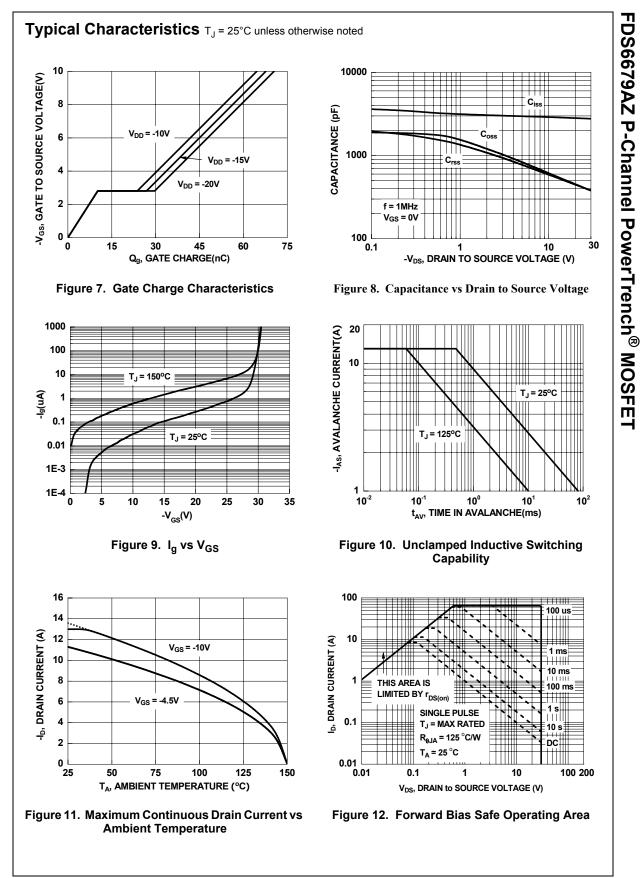
Pulse Test:Pulse Width <300μs, Duty Cycle <2.0%
The diode connected between the gate and source serves only as protection against ESD. No gate overvoltage rating is implied.



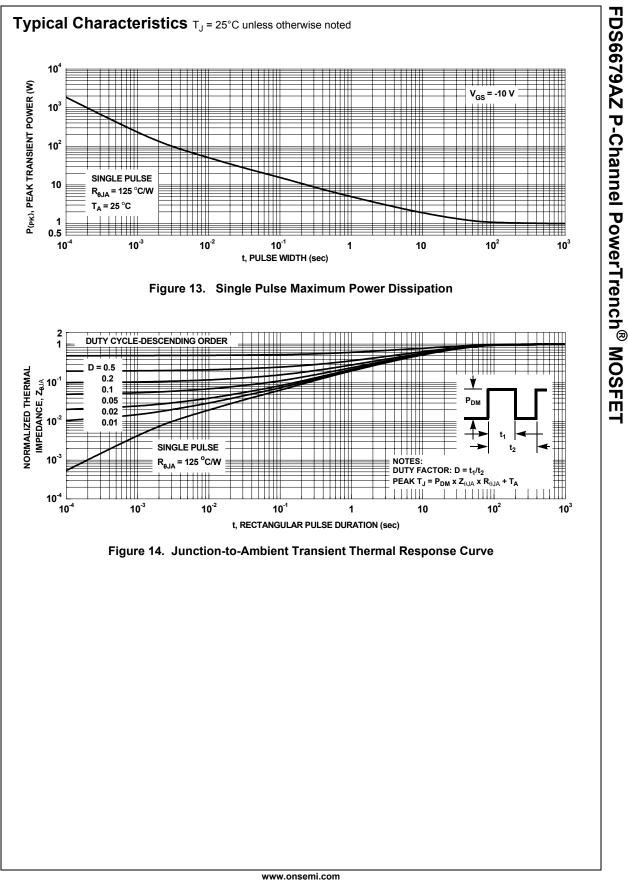
c) 125°C/W when mounted on a minimun pad

FDS6679AZ P-Channel PowerTrench® MOSFET





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